

12-10-01

Date: November 13, 2001
Docket No.: IR-2972(AA)

A

THE COMMISSIONER OF PATENTS AND TRADEMARKS
Box Patent Application
Washington, DC 20231

Sir:

Transmitted herewith for filing is the patent application of:

Inventors: Dennis J. Damico and David R. Pugne

For: Low Read-Through Epoxy Bonded SMC

Enclosed are:

- ☒ A specification including 19 pages and 18 claims.
- ☒ Executed Declaration, Power of Attorney and Property Rights Statement.
- ☒ Executed Assignment to Lord Corporation with Recordation Form Coversheet
- ☒ Information Disclosure Statement including Form PTOL-1449 with copies of cited references.
- ☒ Postal Card for Acknowledgment of Receipt.

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	Other Than A Small Entity	
For:	No. Filed	No. Extra	Rate	Fee
Basic Fee				\$740.00
Total Claims	18 - 20 =	* 0	x 18 =	\$0.00
Indep Claims	2 - 3 =	* 0	x 78 =	\$0.00
Multiple Dependent Claims Presented			+ 270 =	\$0.00
Assignment Recordation Fee			\$40.00	\$40.00
*If the difference in Col. 1 is less than zero, enter "0" in Col. 2.			Total	\$780.00

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- ☒ The Commissioner is hereby authorized to charge payment of any additional fees associated with this communication or credit any overpayment to Deposit Account No. 12-2143.

Facsimile: (919) 469-5226

Registration No. 35,115

Certificate of Express Mail under 37 CFR §1.10

I hereby certify that the above identified application entitled "***Low Read-Through Epoxy Bonded SMC***" including the requisite filing fee, is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" under 37 CFR 1.10 on November 13, 2001 and is addressed to Commissioner of Patents and Trademarks, Washington, DC 20231.

Signed

Date _____

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